

# PRIMERGY TX200 S7

# System configurator and order-information guide

# August 2014

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**PRIMERGY Server** 

# Instructions

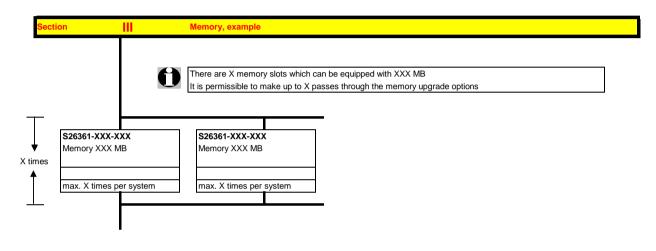
This document contains basic product and configuration information that will enable you to configure your system via PC-/System-Architect

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/System-Architect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



In one chapter you can only select as many components (here 4x) as the arrow indicates.



Please note that there are information symbols which indicate necessary information.



#### Further information in the internet see:

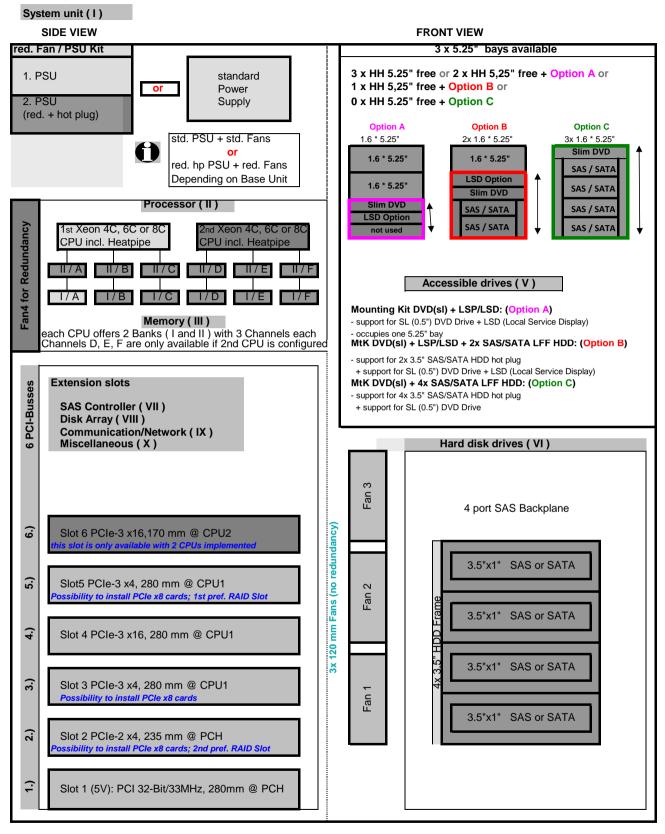
http://ts.fujitsu.com/products/standard\_servers/index.html (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy\_config/current/Pages/default.aspx (extr

(extranet)

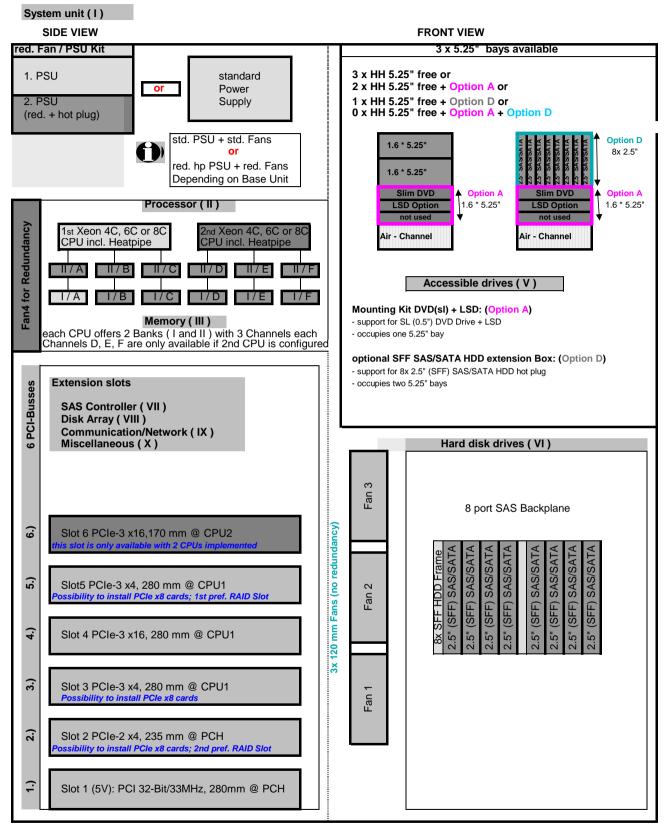
Prices and availability see price list and PC-/System-Architect. Subject to change and errors excepted.

# Configuration diagram PRIMERGY TX200 S7 SATA LFF (3.5") System Unit

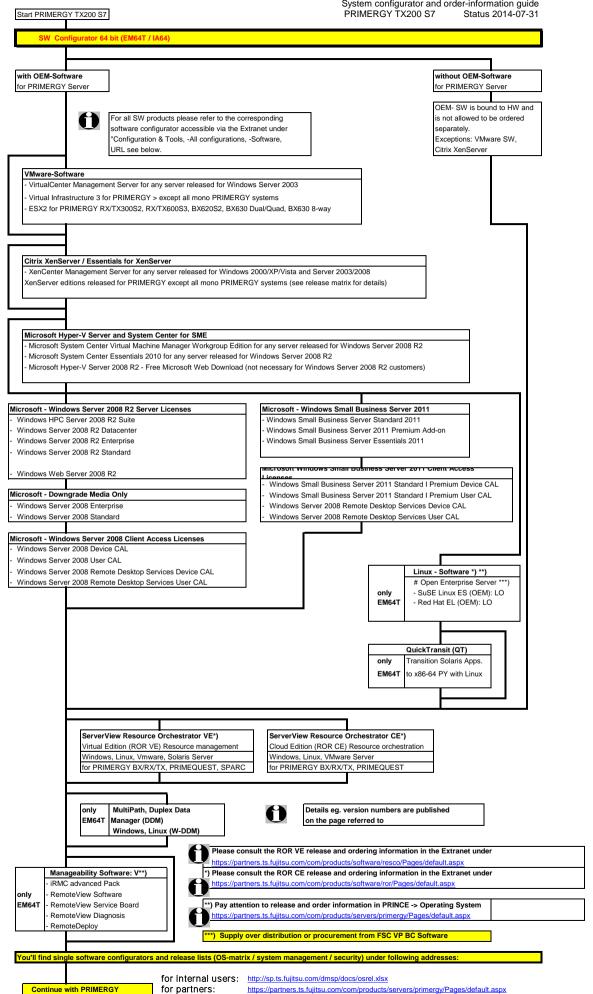


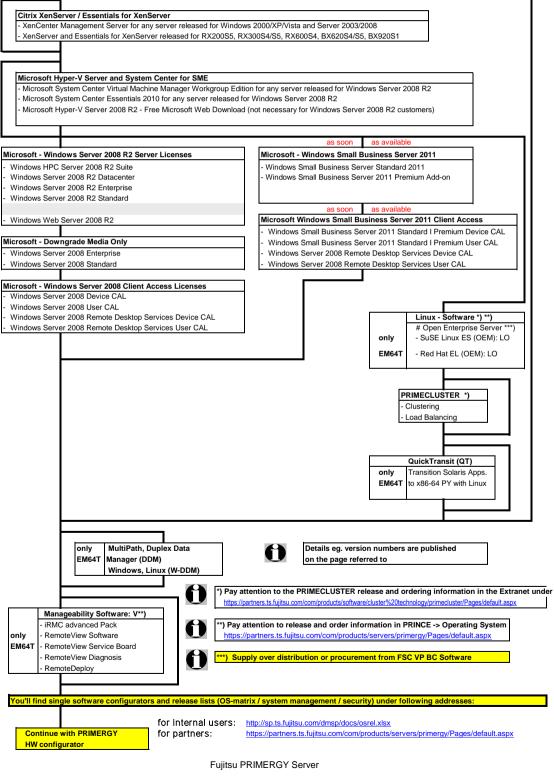
Key:
Included in basic unit
Option

# Configuration diagram PRIMERGY TX200 S7 SFF (2.5") System Unit



Key:
Included in basic unit
Option





Basic unit

#### System unit, Rack and Floorstand, including:

Two lockable front covers in floorstand version

Door #1 for accessible drive bays

Door #2 for hot plug HDD bays

Both doors may be locked or door #1 may be left open while door #2 is still locked

backplane with 4 (LFF) or 8 (SFF) bays for hot-plug HD's. Type depending on base unit:

Type 1: 4x hot plug LFF (3.5") SAS/SATA HDD (SAS/SATA LFF base units only)

Type 2: 8x (2x4) hot plug SFF (2.5") SAS HDD (SAS SFF base units only)

PSU and Fan Type depending on base unit:

Type 1: standard PSU and standard Fans (3 System Fans)

(V101and V301, V501 and V701 base units)

Type 2: without PSU (450W or 800W must be added), but 1 additional fan for redundancy

(V201, V401, V601 and V801 base units)

for Type 1 base units there is an upgrade to

hot plug redundant PSU and redundant Fans available

3 bays 5.25" for accessible drives (half Hight)

Systemboard D3099 with:

Up to two Xeon 4C, 6C & 8C CPU's (Socket-B2)

with 1 serial QPI link ( Quick Path Interconnect ) and 3 memory channels per CPU

First CPU has to be selected for an orderable basic unit,

Chipset Intel® C600 Series (codenamed Patsburg)

6 PCI slots: - 2x PCle-3 x16

- 2x PCle-3 x4 (mechanically x8)

- 1x PCIe-2 x4 (mechanically x8)

- 1x PCI 32/33

- No mix of registered and unbuffered modules is allowed
- First Memory ( one module ) has to be selected for an orderable basic unit per CPU
- Memory upgrade is possible module wise for the Independent Channel Mode or for the Performance Mode,
- Memory mirrroring is supported with 2 identical modules in channel B+C CPU 1 or E+F CPU 2
- Hot Spare Memory is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2
- SDDC (Chipkill) is supported only for registered memory modules,
- 6-port SATA controller on-board included in Intel Southbridge Patsburg A for SATA Raid0/1, optional Southbridge Patsburg B with 4 ports for SAS RAID 0/1

Max. 4 SATA / SAS HD's are supported

Max. 2 SATA accessible drives are supported (DVD, Backup)

2x1 Gbit Ethernet LAN on board (Intel Hartwell):

iSCSI boot integrated in System BIOS as selectable option

iRMC S3 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100 Service LAN-port and

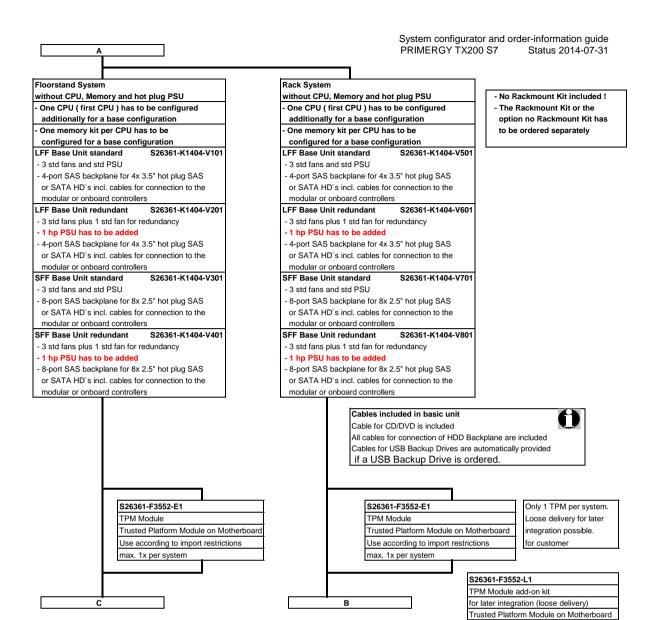
integrated graphics controller ( max. Resolution: 1600 x 1200 at 16 bpp)

The Service LAN-port can be switched alternatively on standard Gbit LAN port Interfaces:

- 1x RS-232-C (serial, 9pin) (usable for BMC or OS or shared)
- 1x VGA (15 pin)
- 9x USB 2.0 (UHCI) with 480MBit/s (4x external at the rear, 2x external at the frontside, 3x internal for backup or UFM)
- 2x LAN RJ45, 1x Service-LAN RJ45

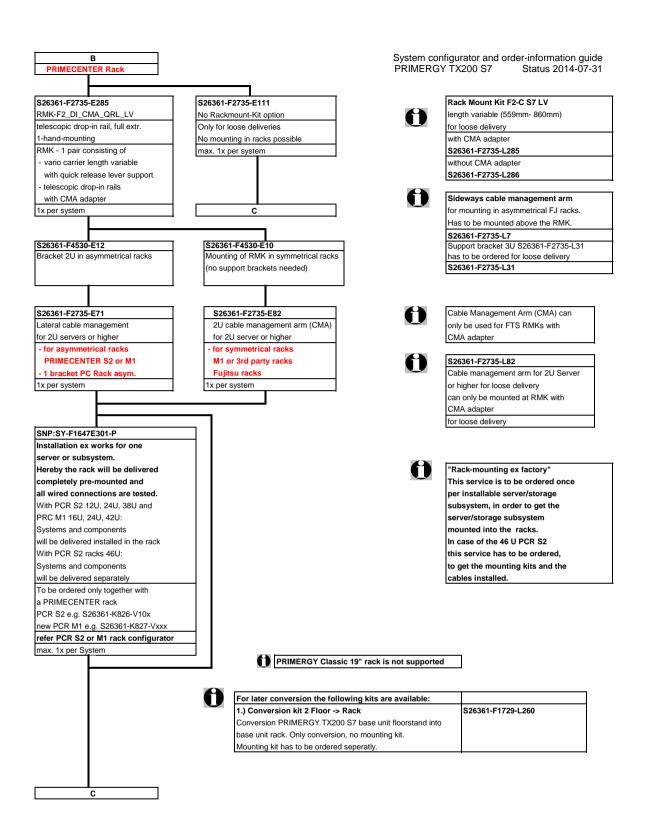
\*internal Cables:

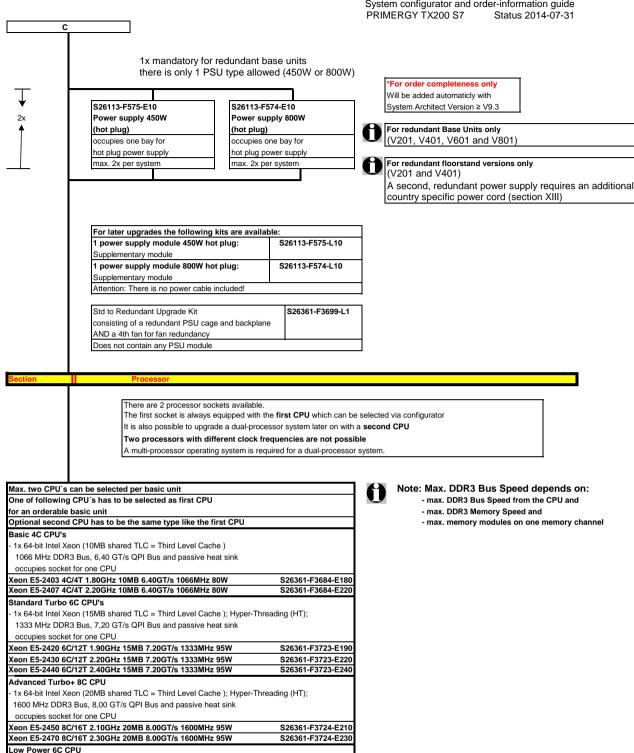
- 1. SATA cable for CD/DVD.
- 2. Cable for HDD Backplane
- 3. USB cable (if USB Backup is used)
- ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
- Documentation engl. (multilingual on CD)



Use according to import restrictions

max. 1x per system





S26361-F3725-E200

1x 64-bit Intel Xeon (15MB shared TLC = Third Level Cache ); Hyper-Threading (HT);

1333 MHz DDR3 Bus, 7,20 GT/s QPI Bus and passive heat sink

Xeon E5-2430L 6C/12T 2.00GHz 15MB 7.20GT/s 1333MHz 60W

occupies socket for one CPU

D



- There are 6 memory slots per CPU for max.

96GB RDIMM (6x 16GB 2R) 24GB UDIMM (6x 4GB)

=> max. 192GB for two CPU's ( 96GB per CPU ), using RDIMM

The memory area is divided into 3 channels per CPU with 2 slots per channel

Registered and unbuffered memory modules can be selected No mix of registered and unbuffered modules allowed.

Memory can be operated at 1.5V or 1.35V, even if the modules are of low voltage type.

Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2.

Memory operating voltage can be set within BIOS (1.5V is default setting for max. speed).

In a 2 DIMMs per channel configuration, following frequencies are supported: - 1.5V - 1600MHz max (depending on CPU, special memory modules)

- 1.35V - 1333MHz max (depending on CPU)

SDDC (Chipkill) is supported for registered x4 organized memory modules only

#### 1.) In the "Independent Channel Mode" is following configuration possible

Channels can be populated in any order in Independent Channel Mode. All 3 channels may be populated in any order and have no matching requirements. All channels must run at the same interface frequency but individual channels may run at different DIMM timings (RAS latency, CAS latency, and so forth)

No mix of registered and unbuffered modules allowed.

#### 2.) "Rank Sparing Mode" configuration

- Within a memory channel, one rank is a spare of the other ranks.

The Spare Rank is held in reserve and is not available as system memory

For the effective memory capacity, please refer to the spreadsheet below.

The BIOS is set to the rank sparing setting.

Minimum configuration is: 2x 1R, 2x 2R or 1x4R DDR3 module per channel

This mode is not supported by x8 organized memory modules

#### 3.) "Performance Mode" configuration

- In this configuration, the memory module population ex factory is spread across all channels.

The BIOS is set to the max. performance for memory.

Minimum configuration is: 3x identical modules

#### 4.) In the "Mirrored Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 2x registered memory modules

In each memory bank channel B and C of CPU 1 or channel E and F of CPU 2 have to be equipped with identical modules for mirrored channel mode.

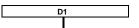
In channel C is always the mirrored memory of channel B of CPU 1

In channel F is always the mirrored memory of channel E of CPU 2

Minimum configuration is: 2x identical modules

This mode is not supported by x8 organized memory modules

D1



S26361-F3694-E10 Independent Mode

Independent Channel Mode allows all channels to be populated in any order. No specific Memory RAS features are defined

Requires min 1 memory Module per CPU

S26361-F3695-E1 Rank Sparing Mode Installation

BIOS Setup factory preinstalled to this mode. One Rank is spare of other ranks on the same channel. Spare Rank is not shown in System Memory. For effective capacity within a channel, please have a look below.

Supported for RDIMM only.

1x per CPU

S26361-F3695-F3

Requires min 2x 1R/2R or 1x 4R modules per CPU S26361-F3695-E2 Performance Mode Installation

BIOS Setup factory preinstalled for max. Performance, LV memory might be set to 1.5V operation. 3 identical memory modules

will be equipped in one memory bank to achieve highest memory performance. All 3 modules are active and full capacity can be used.

Multiple of 3 identical modules to be configured per CPU

Mirrored Channel Mode Installation

BIOS Setup factory preinstalled to this mode. 2 identical memory modules are always equipped in one memory bank to use the

Mirrored channel Mode. Only two modules contain active data, the remain two modules contain mirrored data

Supported for RDIMM only.

Multiple of 2 identical modules to be configured per CPU



Effective Memory capacity / Rank Sparing Mode, 1 Channel populated											
	UDIMM					RDIM					
	2GB	1R	2GB	2R	4GB	1R	8GB	2R	16GB 2F	2	
1DPC	na		na		na		na		na		
2DPC	na		na		4GB		12GB		24GB		



#### Minimum one memory module or order code per CPU = first memory

Unbuffered Memory (UDIMM) no SDDC (chipkill) support

one DDR3 unbuffered ECC mem. Module, 1.35V

Choose up to 6 order codes per CPU

2GB (1x2GB) 1Rx8 L DDR3-1600 U ECC	S26361-F3694-E513
4GB (1x4GB) 2Rx8 L DDR3-1600 U ECC	S26361-F3694-E514

#### Registered Memory (RDIMM) with SDDC (chipkill) support

one DDR3 registered ECC mem. Module, 1.35V 1600MHz supported with up to 2DPC (8 modules/CPU)

at 1.5V

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6x per

CPU, max. 2 modules

per channel

Choose up to 6 order codes per CPU

4GB (1x4GB) 1Rx4 L DDR3-1600 R ECC	S26361-F3697-E514
8GB (1x8GB) 2Rx4 L DDR3-1600 R ECC	S26361-F3697-E515
16GB (1x16GB) 2Rx4 L DDR3-1600 R ECC	S26361-F3697-E516

Note 1.)

Max. DDR3 memory speed depends on the memory configuration (No of mem modules per channe) as well as on the CPU type. The memory channel with the lowest speed defines the speed of all CPU channels in the system, also for the channels of the second CPU if configured.

For real memory speed (depending on memory type / population),



Mix of memory modules is only possible within the same group

## **Memory Configuration PRIMERGY TX200 S7**

Each CPU offers 6 Slots for DDR3 Memory Modules organised in 2 Banks and 3 Channels.

If you need more than 6 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 2 different kinds of DDR3 Memory Modules available: UDIMM and RDIMM UDIMM / RDIMM offer different functionality. Mix of UDIMM / RDIMM is not alloved.

#### If 1.5V and 1.35V DIMMs are mixed, the DIMMs will run at 1.5V

Mode	Configuration	UDIMM	RDIMM	RDIMM	Application		
		ODIMIN	KDIIVIIVI				
		х8	х8	x4			
SDDC (chipkill) support	any	no	no	yes	detect multi-bit errors		
Independant Channel	1, 2 or 3 Modules per Bank	yes	yes	yes	offers max. flexibility, upgradeability, capacity		
Mode					use UDIMM modules for lowest cost		
Mirrored Channel Mode *)	2 identical Modules / Bank	no	no	yes	offers maximum security		
Performance Mode	3 identical Modules / Bank	yes	yes	yes	offers maximum performance and capacity		
Rank Sparing Mode *)	min. 2 Ranks / Channel	no	no	yes	balances security and capacity		

<sup>\*)</sup> For the delivery ex works the system will be prepared with dedicated BIOS setting.

Capacity	Configuration	UDIMM	RDIMM	Notes
Min. Memory per CPU	1 Module / CPU	1x2GB	1x4GB	with one CPU
Max. Memory per CPU	4/6 Modules / CPU	6x4GB	6x16GB	with one CPU
Max. Memory per System	8/12 Modules / System	48GB	96GB	if second CPU is configured

#### Memory-Speed:

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU The memory channel with the lowest speed defines the speed of all CPU channels in the system

Mem. Speed provided by CPU				memory-bus speed depending on CPU type, iguration (DPC) and voltage setting (BIOS)								
	UDIMM 1600MHz					RDIMM 1600MHz						
Voltage setting (BIOS)	1.5V [default]		ault]	1.35V			1.5V [default]			1.35V		
	1 2		1	2		1	2	3	1	2		
	DPC	DPC		DPC	DPC		DPC	DPC	DPC	DPC	DPC	
CPU with 1600MHz DDR3 Bus	1333	1066		1333	1066		1600	1600	-	1333	1333	
CPU with 1333MHz DDR3 Bus	1333	1333		1066	1066		1333	1333	-	1333	1333	
CPU with 1066MHz DDR3 Bus	1066	1066		1066	1066		1066	1066	-	1066	1066	

1R - Single Rank

2R - Dual Rank

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel

#### Configuration hints:

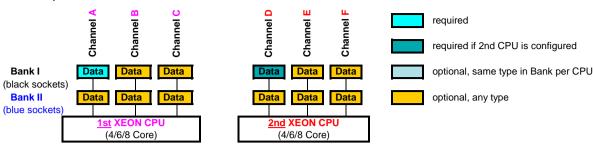
- The memory sockets on the systemboard offer a color coding:

Bank I black sockets
Bank II blue sockets

A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)
 Bank I on CPU 1/2 up to 3 memory modules connected to Channel A - F on the 1st/2nd CPU
 Bank II on CPU 1/2 up to 3 memory modules connected to Channel A - F on the 1st/2nd CPU

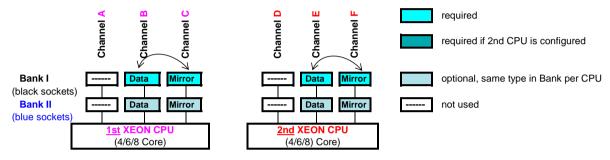
- See below and next page for a detailed descriptions of the memory configuration supported.

## 1. Independent Channel Mode



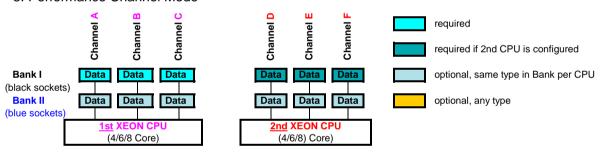
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

#### 2. Mirrored Channel Mode



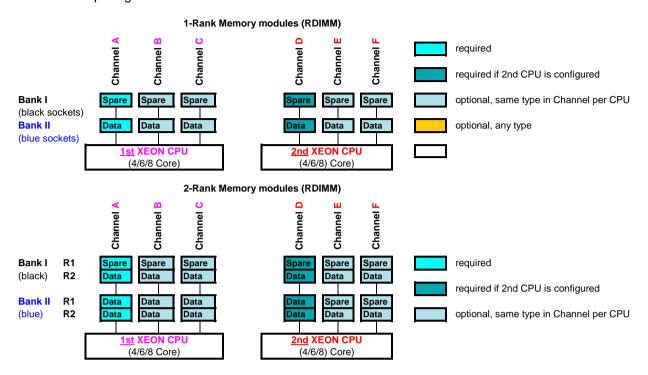
Mirrored Channel Mode requires identical modules on channel B / C (1st CPU) or channel E / F (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory If this mode is used, a multiple of 2 identical modules has to be ordered.

## 3. Performance Channel Mode

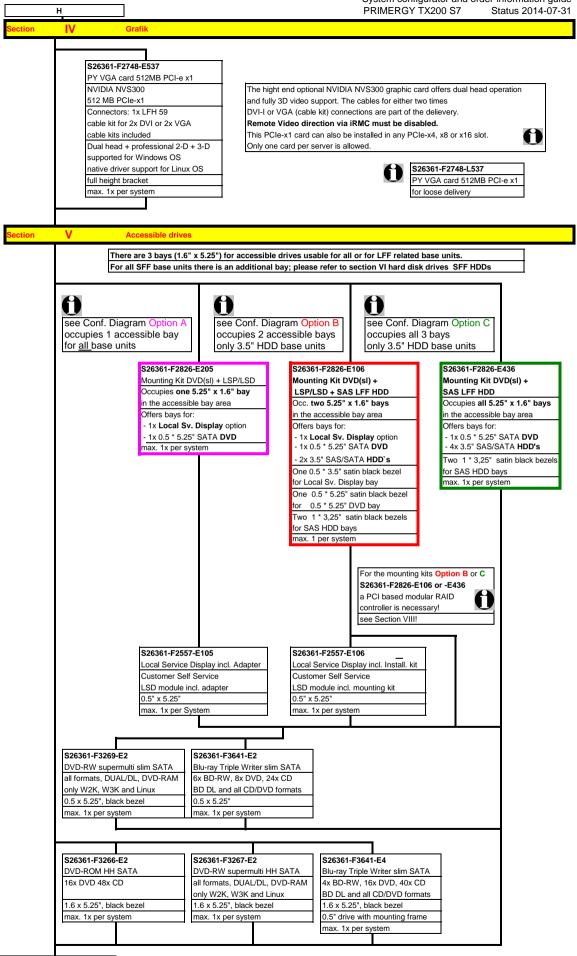


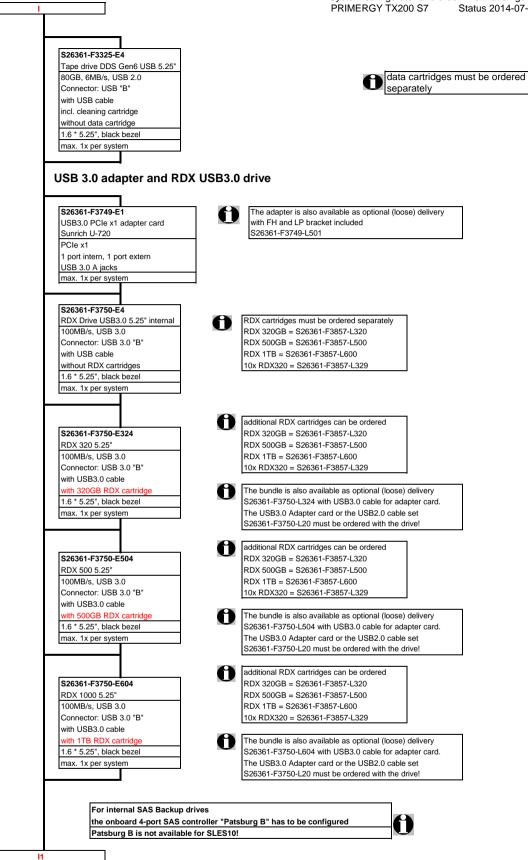
Performance Channel Mode requires identical modules on all channels of each Bank per CPU. If this mode is used, a multiple of 3 identical modules has to be ordered.

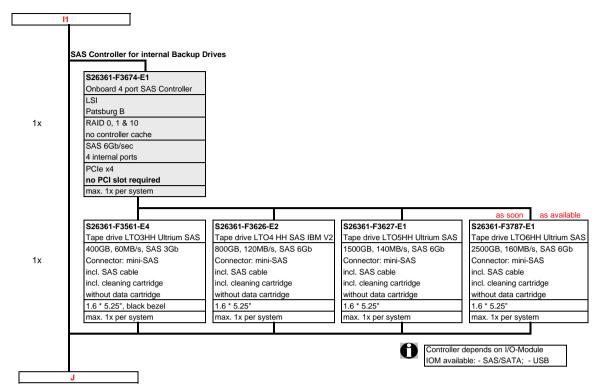
# 4. Rank Sparing Mode



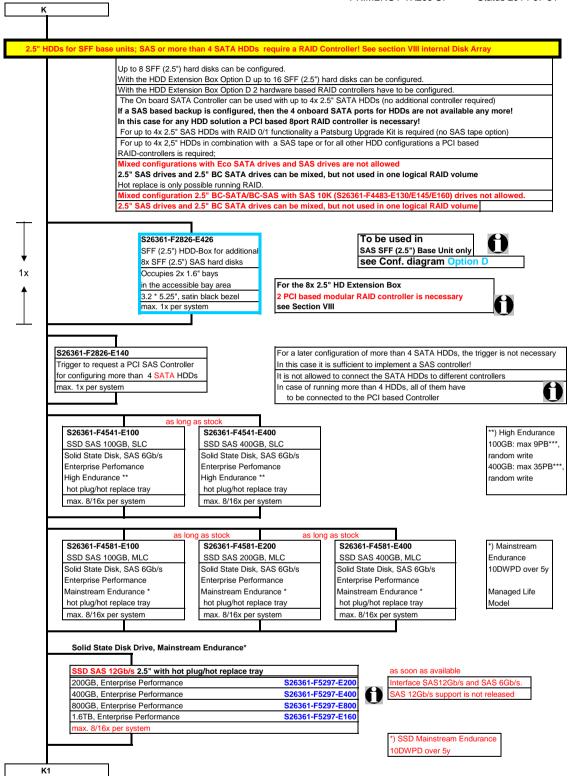
Rank Sparing Mode requires identical modules (same capacity and technology) within the same channel. The available memory for applications will vary depending on configuration. Please refer to the spreadsheet above "Effective Memory capacity with active Rank Sparing Mode". Population rule for Rank sparing mode is to achieve max. available memory.

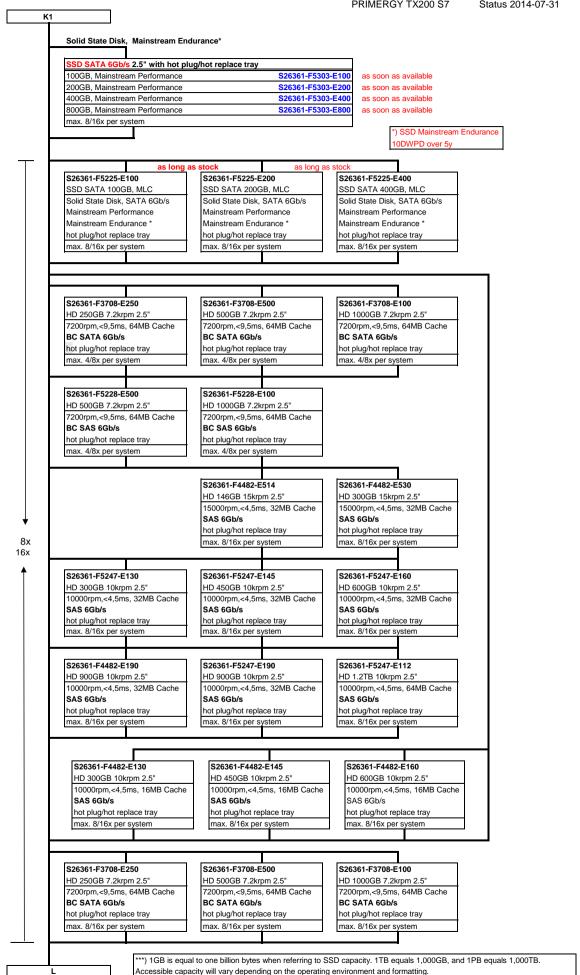


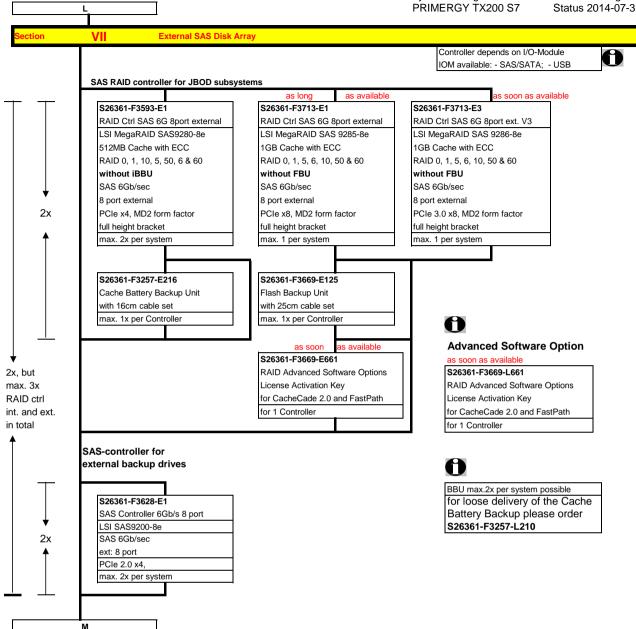


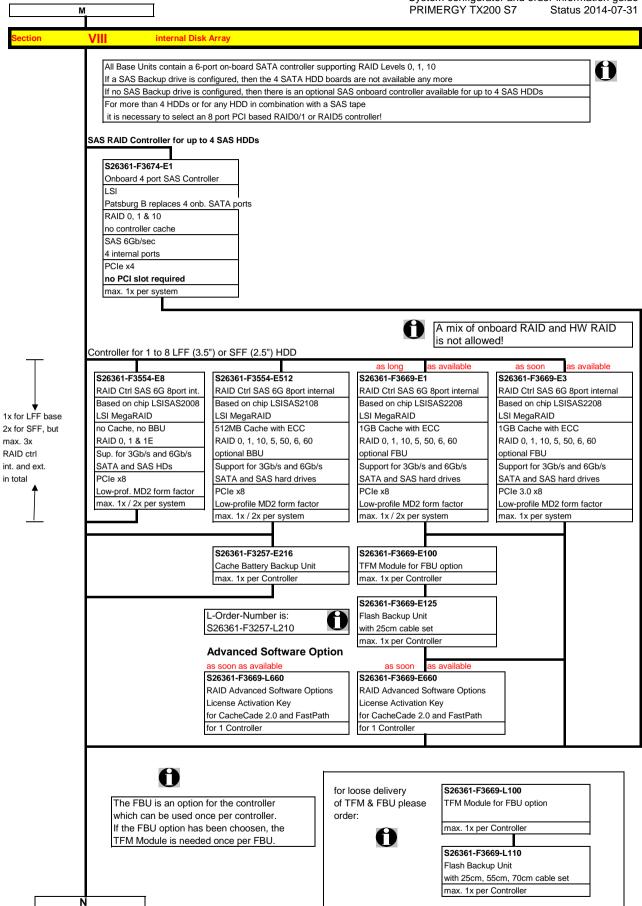


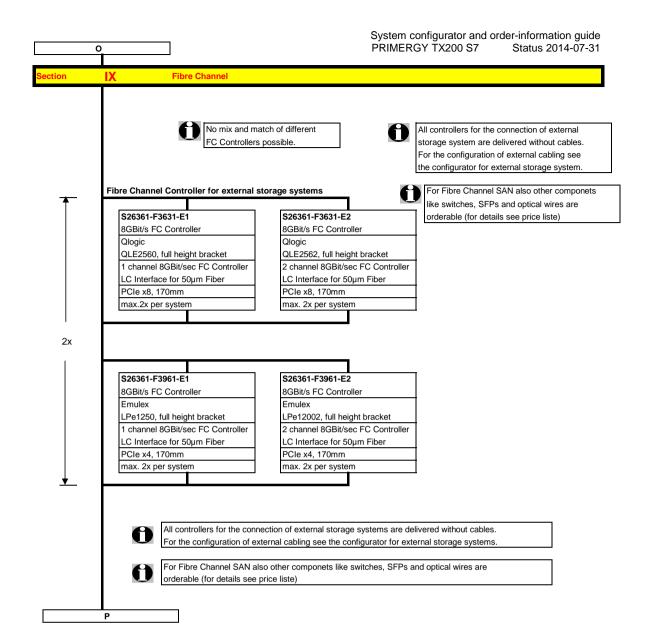
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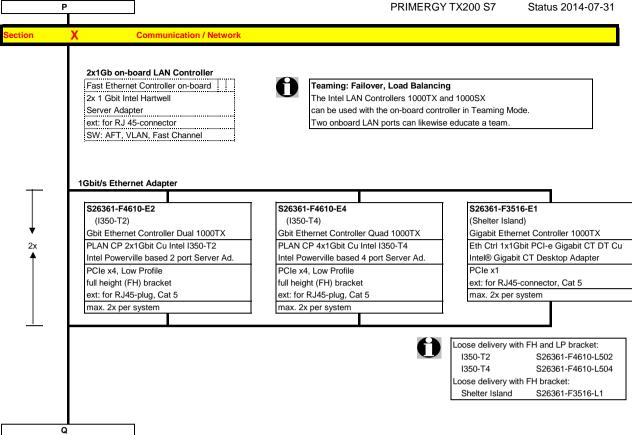


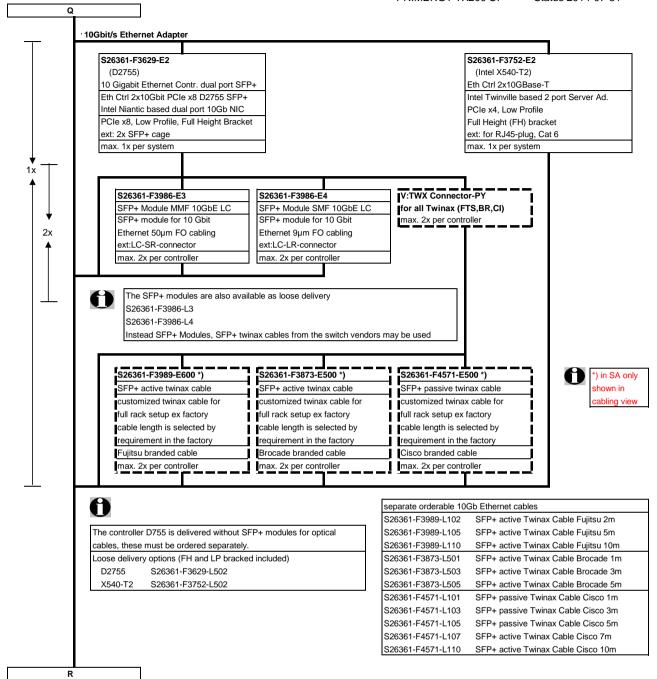


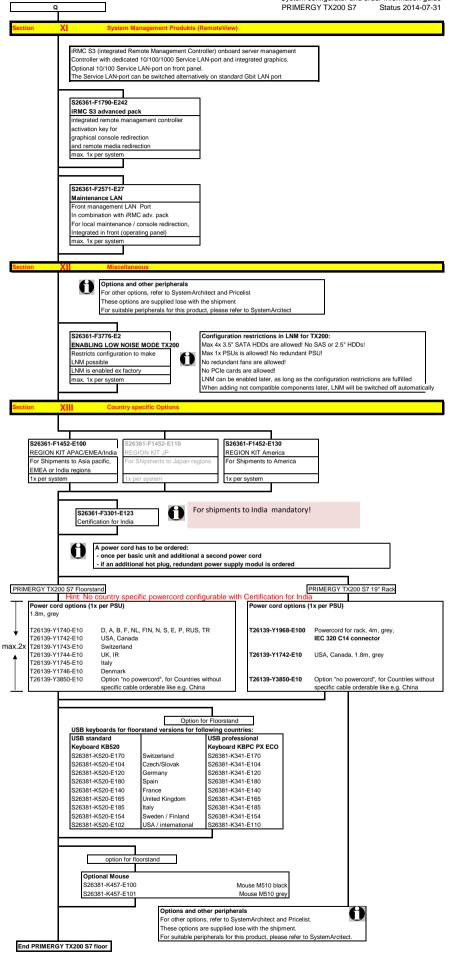












# **Change Report**

Date	Order number	Changes
2014-06-30	S26361-F3301-E123	Added certification for India
2014-06-16	S26361-F3739-xxx	EOL
2014-06-16	S26361-F3740-xxx	EOL
2014-03-17	S26361-F3739-E201	phase out
2014-03-17	S26361-F3740-E201	phase out
2014-03-17	S26361-F3610-E202	EOL
2014-01-30	S26361-F5247-E112	New 1.2TB 2.5" SAS 6G HDD added.
2014-01-30	S26361-F5303-*	New SATA SSDs added.
2014-01-30	S26361-F5297-*	New SAS SSDs added.
2013-10-18	Optional USB Comps	no longer available
2013-10-16	DDS3	removed from Configurator due to EoL
2013-07-16	HH DVDs	cut connection between HH ODD & slim frame
2013-07-15	F2735-L7 & L286	Tab: Basi Unit, RMK update
2013-05-28	S26361-F3738-E1	LTO6 added
2013-05-23	S26361-F3713-E3	RAID Ctrl SAS 6G 8Port ex 1GB LSI V3
2013-05-16	S26361-F3670-E400	New 3.5" BC-SATA 7.2K HDD 4TB
2013-05-16	S26361-F5241-E*	New 3.5" BC-SAS 7.2K HDD 1/2/3/4TB
2013-05-13		HDD & SSD description text updated
2013-03-25	S26361-F3669-E660/L660	RAID advanced SW option added - for RAID Ctrl SAS 6G 1GB (D3116C) added
2013-03-25	S26361-F3669-E3	RAID Ctrl SAS 6G 1GB (D3116C) added
2013-03-25	S26361-F3669-E661/L661	RAID advanced SW options added - for RAID Ctrl SAS 6G 8port external
2013-03-18	S26361-F3750-E324/504/E604	RDX & Cartridge bundles added
2012-12-13	S26361-F3641-E4	BD slim with frame included again
2013-01-08	S26361-F5228-E100	New 2.5" BC SAS 7.2K HDD
2013-01-08	S26361-F5247-E130	New 2.5" SAS 10K HDD (mix with BC-SATA supported, successor for *F5227*)
2012-12-13	S26361-F3641-E4	BD slim with frame removed
2012-12-07	S26361-F2826-E106	HDD box w/o LSD possible
2012-12-07	S26381-K520-E170	new keyboard numbers introduced
2012-12-07	S26381-K457-E100	new mouse numbers introduced
2012-12-07	S26361-F3776-E2	ENABLING LOW NOISE MODE TX200 added
2012-11-22	F3749-E4 and F3750-E4	"as soon as available" removed
2012-11-22	S26361-F3857-E4	"as long as available" added
2012-10-08	S26361-F3749-Ex	Added USB3.0 Adapter
2012-10-08	S26361-F3750-Ex	Added RDX Drive
2012-09-28	S26361-F4541-E200	EOL SSD SAS 200GB SLC
2012-09-05		SFF(2,5") HDD Extensionbox needs 2 modular Raid Controller
2012-08-16		BBU/FBU cable length in text corrected (UJ)
2012-08-01		first release